

APPLICATION FORM

Please send completed application form to the 2026 Engineering Innovation and Technology Forum industry liaison team at thomas.howden@wearemci.com

CONTACT DETAILS OF APPLICANT

Mr Mrs Ms Miss Dr Prof Other

Given name Family name

Position

Organisation name (for invoicing purposes)

Organisation name (for marketing purposes)

Address

State Country Postcode

Email Phone ()

Website Mobile

Onsite contact person name Onsite contact person number

Sponsorship option	Investment (AUD incl GST)	Number of opportunities
Networking		
TMR dinner	\$22,500	1
Industry breakfast	\$17,500	1
Forum networking event	\$10,000	1
Great debate	\$5,000	1
Delegate experience		
Exhibitor lounge	\$12,500	1
Coffee cart	\$12,500	4
Delegate bag	\$10,000	1
Delegate gift (power bank)	\$10,000	1
Headshot studio	\$10,000	1
Exhibition networking activation (Juice Bike)	\$5,000	1
Advertising		
Forum app advertisement	\$1,000	5
Digital poster advertising	\$1,000	5
Delegate bag insert	\$1,000	5
Total sponsorship investment	\$	

Booth type	Price	Number of booths/sqm required	Total \$
Shell scheme (3m x 3m)	\$6,600		
Space only (3m x 3m)	\$5,600		

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Exhibition Details

Location: The conference managers will endeavour to allocate space in line with your request, however this cannot be guaranteed. If your preferred space is not available you will be contacted to discuss alternative options.

Preferred booth location: 1.

2.

3.

I do NOT wish to be located adjacent to these companies:

I wish to be located adjacent to these companies:

Confirmation

My signature below confirms my application to sponsor or exhibit at the Engineering Innovation and Technology Forum, and acceptance of the terms and conditions of partnership/exhibiting. Once this application is accepted, your partnership or exhibition purchase will be confirmed with written communication from the Engineering Innovation and Technology Forum industry liaison team.

Insert TOTAL amount payable Title Name (please print clearly) Position in organisation

AUD
inc GST

Signature Date (DD/MM/YY)

Signature

/ /

I do NOT wish to receive conference updates via email.

EITF partnership and exhibition terms and conditions available [here](#)

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